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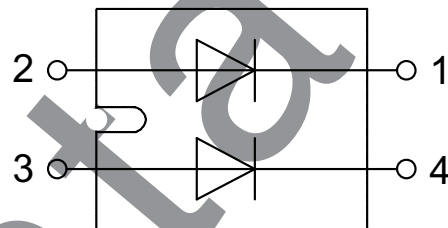
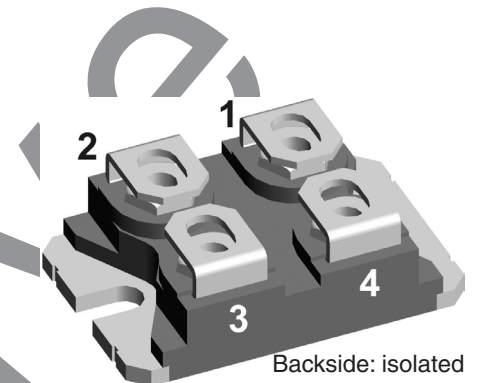
SiC Schottky Diode

$$V_{RRM} = 1200 \text{ V}$$

$$I_{FAV} = 2 \times 49 \text{ A}$$

Ultra fast switching
Zero reverse recovery

Part number
DCG100X1200NA

**Features / Advantages:**

- Ultra fast switching
- Zero reverse recovery
- Zero forward recovery
- Temperature independent switching behavior
- Positive temperature coefficient of forward voltage
- $T_{vj} = 175^{\circ}\text{C}$

Applications:

- Solar inverter
- Uninterruptible power supply (UPS)
- Welding equipment
- Switched-mode power supplies
- Medical equipment
- High speed rectifier

Package: SOT-227B (minibloc)

- Isolation Voltage: 3000 V~
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Base plate with Aluminium nitride isolation for low thermal resistance
- Advanced power cycling

Terms & Conditions of Usage

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact the sales office, which is responsible for you. Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you.

Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend

- to perform joint risk and quality assessments;
- the conclusion of quality agreements;

- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

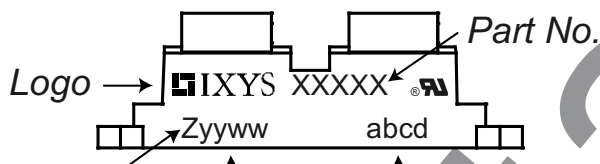
SiC Diode				Ratings		
Symbol	Definitions	Conditions	min.	typ.	max.	
V_{RSM}	max. non-repetitive reverse blocking voltage				1200	V
V_{RRM}	max. repetitive reverse blocking voltage				1200	V
I_R	reverse current	$V_R = V_{RRM}$		100 300	500 1000	μ A μ A
V_F	forward voltage	$I_F = 25$ A		1.25		V
		$I_F = 50$ A		1.6	1.8	V
		$I_F = 25$ A $I_F = 50$ A	$T_{VJ} = 175^\circ\text{C}$	1.55 2.25	2.7	V V
I_{FAV}	average forward current	$T_C = 80^\circ\text{C}$	} rectangular, d = 0.5 $T_{VJ} = 175^\circ\text{C}$		49	A
		$T_C = 100^\circ\text{C}$		43	A	
I_{F25}	forward current		$T_C = 25^\circ\text{C}$		86	A
I_{F80}			$T_C = 80^\circ\text{C}$		66	A
I_{F100}			$T_C = 100^\circ\text{C}$		59	A
I_{FSM}	max forward surge current	t = 10 ms, half sine (50 Hz) $t_p = 10 \mu\text{s}$, pulse			250	A A
Q_C	total capacitive charge	$V_R = 800$ V, $I_F = 50$ A $di/dt = 200$ A/ μ s			250	nC
C	total capacitance	$V_R = 0$ V	} $T_{VJ} = 25^\circ\text{C}$, f = 1 MHz		3380	pF
		$V_R = 400$ V		230	pF	
		$V_R = 800$ V		173	pF	
R_{thJC}	thermal resistance junction to case				0.51	K/W
R_{thJH}	thermal resistance junction to heatsink	with heatsink compound; IXYS test setup			0.66	K/W

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Package Outlines SOT-227B (minibloc)				Ratings		
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal			100	A
T_{stg}	storage temperature		-40		150	°C
T_{op}	operation temperature		-40		150	°C
T_{VJ}	virtual junction temperature		-40		175	°C
Weight					30	g
M_D	mounting torque ¹⁾	screws to heatsink			1.5	Nm
		terminal connection screws			1.3	Nm
d_{Spp}	creepage distance on surface	terminal to terminal	10.5			mm
d_{Spb}		terminal to backside	8.5			mm
d_{App}	striking distance through air	terminal to terminal	3.2			mm
d_{Apb}		terminal to backside	6.8			mm
V_{ISOL}	isolation voltage	t = 1 second	50 / 60 Hz, RMS; $I_{ISOL} \leq 1$ mA		3000	V
		t = 1 minute		2500	V	
C_p	coupling capacity per switch	between shorted terminals of diodes and back side metalization				pF

¹⁾ further information see application note IXAN0073 on www.ixys.com/TechnicalSupport/appnotes.aspx (General / Isolation, Mounting, Soldering, Cooling)

Product Marking



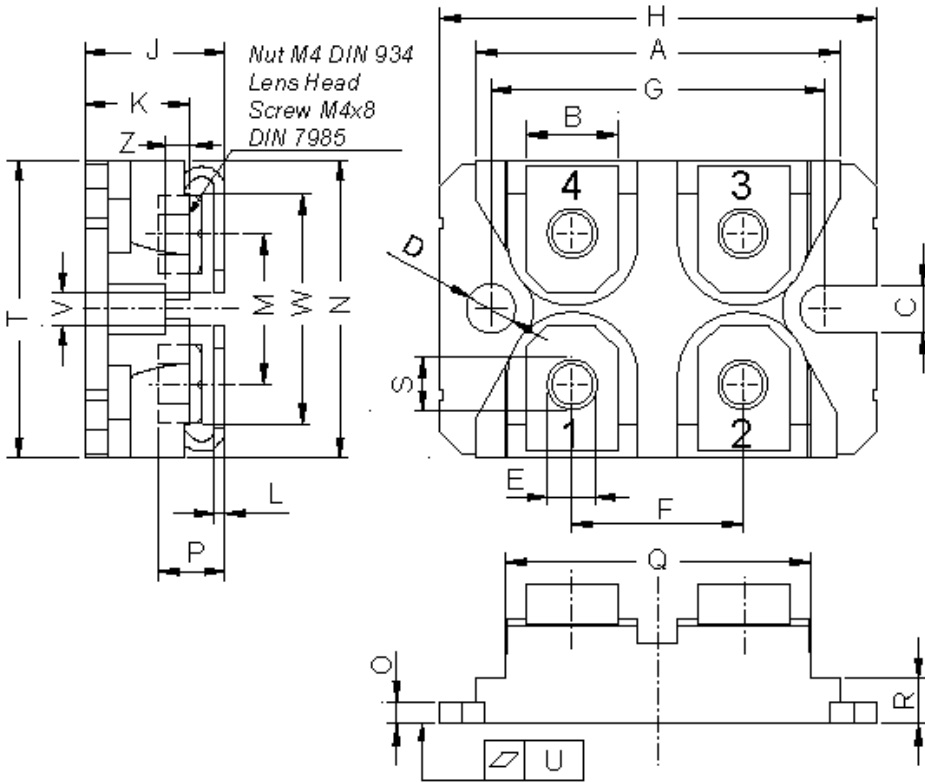
Part description

D = Diode
 C = SiC
 G = extreme fast
 100 = Current Rating [A]
 X = Parallel legs
 1200 = Reverse Voltage [V]
 NA = SOT-227 (minibloc)

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	DCG100X1200NA	DCG100X1200NA	Tube	10	521465

Equivalent Circuits for Simulation ^{* on die level}

		$T_{VJ} = 125^\circ\text{C}$	$T_{VJ} = 175^\circ\text{C}$	
$V_{0\max}$	threshold voltage	0.80	0.73	V
$R_{0\max}$	slope resistance *	28.4	35.2	mΩ

Outlines SOT-227B (minibloc)


Dim.	Millimeter		Inches	
	min	max	min	max
A	31.50	31.88	1.240	1.255
B	7.80	8.20	0.307	0.323
C	4.09	4.29	0.161	0.169
D	4.09	4.29	0.161	0.169
E	4.09	4.29	0.161	0.169
F	14.91	15.11	0.587	0.595
G	30.12	30.30	1.186	1.193
H	37.80	38.23	1.488	1.505
J	11.68	12.22	0.460	0.481
K	8.92	9.60	0.351	0.378
L	0.74	0.84	0.029	0.033
M	12.50	13.10	0.492	0.516
N	25.15	25.42	0.990	1.001
O	1.95	2.13	0.077	0.084
P	4.95	6.20	0.195	0.244
Q	26.54	26.90	1.045	1.059
R	3.94	4.42	0.155	0.167
S	4.55	4.85	0.179	0.191
T	24.59	25.25	0.968	0.994
U	-0.05	0.10	-0.002	0.004
V	3.20	5.50	0.126	0.217
W	19.81	21.08	0.780	0.830
Z	2.50	2.70	0.098	0.106

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